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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WonJun Ko	12/07/2007
Jong Wook Ju	12/07/2007
SeungYong Chai	12/07/2007
Taeg Ki Lim	12/07/2007
Ja Eun Yun	12/07/2007

RECEIVING PARTY DATA

Name:	STATS ChipPAC Ltd.	
Street Address:	5 Yishun Street 23	
City:	Singapore	
State/Country:	SINGAPORE	
Postal Code:	768442	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11957845

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 27-446

NAME OF SUBMITTER: Mikio Ishimaru

PATENT

REEL: 020257 FRAME: 0246

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Total Attachments: 3 source=27-446_ASSIGNMENT#page1.tif

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PATENT

REEL: 020257 FRAME: 0247

Docket No.: 27-446

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGE SYSTEM WITH PACKAGE INTEGRATION

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, <u>STATS ChipPAC Ltd.</u>, a Corporation of the <u>Republic of Singapore</u>, having a place of business at <u>5 Yishun Street 23</u>, <u>Singapore 768442</u> (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

- 1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

1 of 3

IN	WITNESS	WHEREOF,	the said	Assignor	has	executed	and	delivered	this	instrument	on
the	e date set for	th below.		_							

	2007.12.7
WonJun Ko	Date
furno.	A A
Witness Signature	Witness Signature
Song Ho Lee	Dae Sik Choi
Print Witness Name	Print Witness Name
Dec. 67 107	Dec 07'07
Date '	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

2 2 G	2007. 12. 9
Jong Wook Ju	Date
Huno	
Witness Signature	Witness Signature
Sang Ho Lee	Dae Sik Choi
Print Witness Name	Print Witness Name
nec. 01 '67	Dec 07 '07
Date /	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Chai S Y	2007. 12.7
SeungYong Chai	Date
Jamo	He
Witness Signature	Witness Signature
Soung 1 to Lee	Dae Sik Choi
Print Witness Name	Print Witness Name
Dec 67 .167	Dec 07 '07
Date	Date

Docket No.: 27-446

IN WITNESS WHEREOF, the said Assignor ha	s executed and delivered this instrument on
the date set forth below.	-
ly	201. p.j
Taeg Ki Lim	Date
Pauro	X H
Witness Signature	Witness Signature
Sang Ho lee	Dae Sik Choi
Print Witness Name	Print Witness Name
Dec 07)07	Dec 67 '07
Date	Date
IN WITNESS WHEREOF, the said Assignor hat the date set forth below.	s executed and delivered this instrument or
Ja Eun Yun	Date
Witness Signature	Witness Signature
Sny to lee	Dae Sik Choi
Print Witness Name	Print Witness Name

Dec 01 107.

Date

Dec 07 '07